ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information					
upplier Inform	ation						·								
Company name*			Company unique ID			τ	Unique ID Authority					Response Date*			
nsemi												2023-06-08			
Contact Name		Title - Contact			1	Phone - Contact*					Email - Contact*				
Product-Env-Stewar	rds	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
uthorized Represer	ntative*	Title - Representative			1	Phone - Representative*				Email - Representative*					
Product-Env-Stewar	rds	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Requester	quester Item Number Mfr Iter		em Number Mfr Item Name				Effective Dat	ate Version Manufacturing Site		uring Site	V	Veight*	UOM	Unit Type	
		NCP8107	NCP81075MNTXG High Performance D		Dual MOSFE	ET Gate	2023-06-08		PHM		3	8.61	mg	Each	
Ianufacturing I	Proccess Information	on													
Terminal Plating / Grid Array Material To			Ferminal Base Alloy J-STD-020 MSI			L Rating	Peak Process Body Temperature Max Time at Peak			Temperat	ıre Num	ber of Reflow Cy	cles		
Matte Tin (Sn) - annealed		C	CU Alloy 1			260	260 C 30			seconds 3					
omments															
vel 1 - maximum ti	me at peak temperature	during sol	dering is 10-3	30 seconds											
or more informatio	on regarding material co	mposition	please refer to	page 3							· · · · · · · · · · · · · · · · · · ·				

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correction that such information is true and correction to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.4	mg	Supplier	Silicon (Si)	7440-21-3		0.4	mg
Die Attach	0.95	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.057	mg
			Supplier	Silver (Ag)	7440-22-4		0.7742	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.057	mg
			Supplier	Misc.	Proprietary Data		0.0047	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.057	mg
Lead Frame	14.94	mg	Supplier	Silver (Ag)	7440-22-4		2.9282	mg
			Supplier	Iron (Fe)	7439-89-6		0.1195	mg
			Supplier	Copper (Cu)	7440-50-8		11.8922	mg
Mold Compound-Black	20.0	mg	Supplier	Epoxy resins	129915-35-1		1	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		1	mg
			Supplier	Carbon Black (C)	1333-86-4		0.08	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.46	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		17	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.46	mg
Plating	1.11	mg	Supplier	Tin (Sn)	7440-31-5		1.11	mg
Wire Bond	1.21	mg	Supplier	Palladium (Pd)	7440-05-3		0.0121	mg
			Supplier	Copper (Cu)	7440-50-8		1.1979	mg